Preferred Device

General Purpose Transistor

NPN Silicon

Features

• Pb-Free Packages are Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	40	Vdc
Collector - Base Voltage	V _{CBO}	60	Vdc
Emitter – Base Voltage	V _{EBO}	6.0	Vdc
Collector Current – Continuous	Ic	200	mAdc

THERMAL CHARACTERISTICS

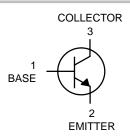
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) T _A = 25°C	P_{D}	225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C	P _D	300	mW
Derate above 25°C		2.4	mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

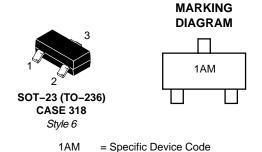
- 1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = $0.4 \times 0.3 \times 0.024$ in. 99.5% alumina.



ON Semiconductor®

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ORDERING INFORMATION

Device	Package	Shipping [†]	
MMBT3904LT1	SOT-23	3000 / Tape & Reel	
MMBT3904LT1G	SOT-23	3000 / Tape & Reel	
MMBT3904LT3	SOT-23	10000 / Tape & Reel	
MMBT3904LT3G	SOT-23	10000 / Tape & Reel	

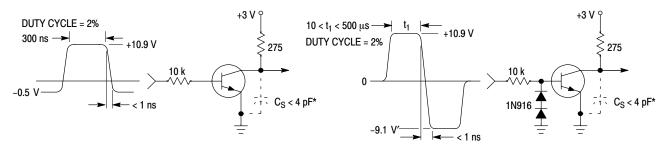
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Chara	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS				<u> </u>	1	
Collector – Emitter Breakdown Voltage (I _C	V _{(BR)CEO}	40	_	Vdc		
Collector – Base Breakdown Voltage (I _C =	10 μAdc, I _E = 0)	V _{(BR)CBO}	60	-	Vdc	
Emitter-Base Breakdown Voltage (I _E = 1	0 μAdc, I _C = 0)	V _{(BR)EBO}	6.0	-	Vdc	
Base Cutoff Current (V _{CE} = 30 Vdc, V _{EB} :	= 3.0 Vdc)	I _{BL}	-	50	nAdc	
Collector Cutoff Current (V _{CE} = 30 Vdc, V	I _{CEX}	-	50	nAdc		
ON CHARACTERISTICS (Note 3)						
$\begin{array}{l} \text{DC Current Gain} \\ \text{(I}_{\text{C}} = 0.1 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 1.0 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 10 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 50 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 100 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \end{array}$	H _{FE}	40 70 100 60 30	- 300 - -	-		
Collector – Emitter Saturation Voltage ($I_C = 10 \text{ mAdc}$, $I_B = 1.0 \text{ mAdc}$) ($I_C = 50 \text{ mAdc}$, $I_B = 5.0 \text{ mAdc}$)		V _{CE(sat)}	- -	0.2 0.3	Vdc	
Base – Emitter Saturation Voltage ($I_C = 10 \text{ mAdc}$, $I_B = 1.0 \text{ mAdc}$) ($I_C = 50 \text{ mAdc}$, $I_B = 5.0 \text{ mAdc}$)		V _{BE(sat)}	0.65 -	0.85 0.95	Vdc	
SMALL-SIGNAL CHARACTERISTICS						
Current – Gain – Bandwidth Product (I _C =	10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	300	-	MHz	
Output Capacitance ($V_{CB} = 5.0 \text{ Vdc}$, $I_{E} =$	0, f = 1.0 MHz)	C _{obo}	-	4.0	pF	
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)		C _{ibo}	-	8.0	pF	
Input Impedance (V _{CE} = 10 Vdc, I _C = 1.0 mAdc, f = 1.0 kHz)		h _{ie}	1.0	10	k ohms	
Voltage Feedback Ratio (V _{CE} = 10 Vdc, I _C = 1.0 mAdc, f = 1.0 kHz)		h _{re}	0.5	8.0	X 10 ⁻⁴	
Small-Signal Current Gain (V _{CE} = 10 Vd	h _{fe}	100	400	-		
Output Admittance ($V_{CE} = 10 \text{ Vdc}$, $I_{C} = 1$	h _{oe}	1.0	40	μmhos		
Noise Figure (V_{CE} = 5.0 Vdc, I_{C} = 100 μ Adc, R_{S} = 1.0 k ohms, f = 1.0 kHz)		NF	-	5.0	dB	
SWITCHING CHARACTERISTICS						
Delay Time	$(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc},$	t _d	-	35		
Rise Time	I _C = 10 mAdc, I _{B1} = 1.0 mAdc)	t _r	-	35	ns	
Storage Time	(V _{CC} = 3.0 Vdc,	t _s	-	200		
Fall Time	$I_C = 10 \text{ mAdc}, I_{B1} = I_{B2} = 1.0 \text{ mAdc})$	t _f	_	50	ns	

^{3.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

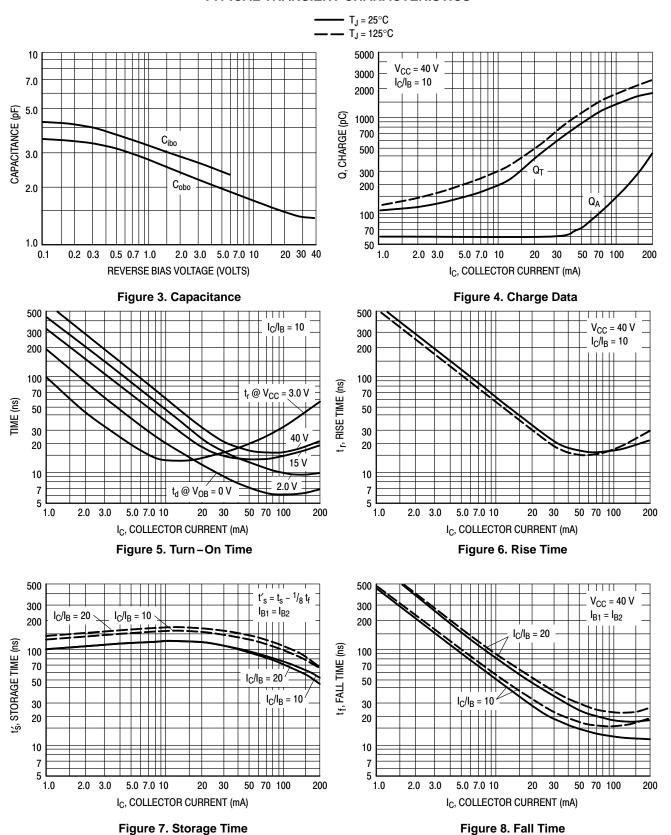


^{*} Total shunt capacitance of test jig and connectors

Figure 1. Delay and Rise Time **Equivalent Test Circuit**

Figure 2. Storage and Fall Time **Equivalent Test Circuit**

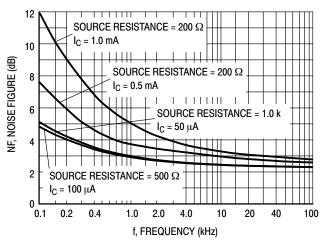
TYPICAL TRANSIENT CHARACTERISTICS



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TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS **NOISE FIGURE VARIATIONS**

 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, Bandwidth = 1.0 \text{ Hz})$



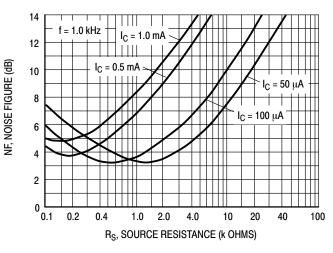
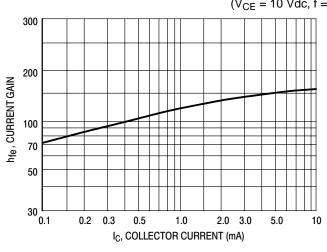


Figure 9.

Figure 10.

h PARAMETERS



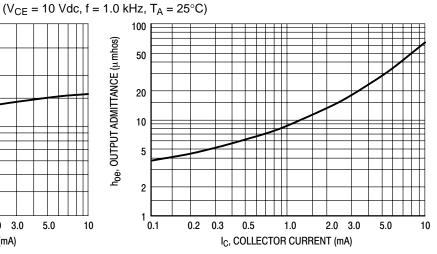
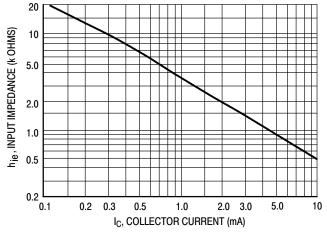


Figure 11. Current Gain

Figure 12. Output Admittance 10



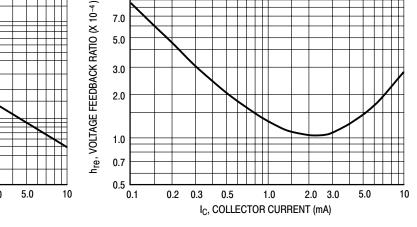


Figure 13. Input Impedance

Figure 14. Voltage Feedback Ratio

7.0

TYPICAL STATIC CHARACTERISTICS

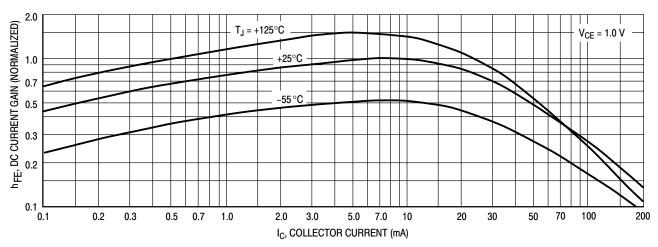


Figure 15. DC Current Gain

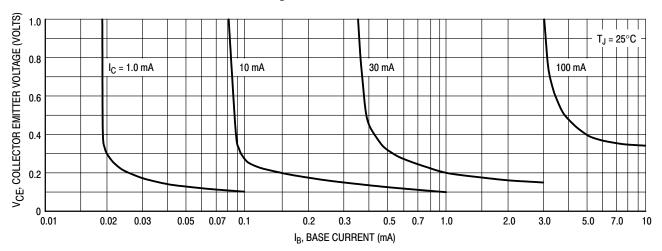


Figure 16. Collector Saturation Region

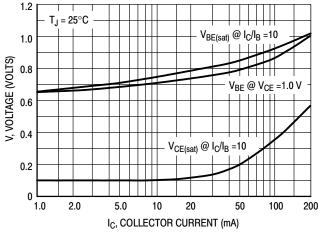


Figure 17. "ON" Voltages

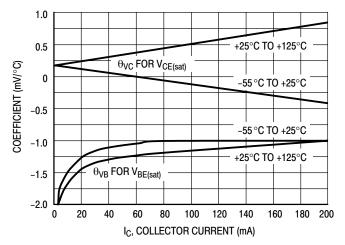
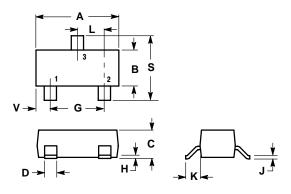


Figure 18. Temperature Coefficients

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AH**



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- CONTROLLING DIMENSION, INCH.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL
- 318-03 AND -07 OBSOLETE, NEW STANDARD

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.1102	0.1197	2.80	3.04
В	0.0472	0.0551	1.20	1.40
С	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
Н	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
٧	0.0177	0.0236	0.45	0.60

STYLE 6:

- PIN 1. BASE 2 **EMITTER**
 - COLLECTOR 3.

SOLDERING FOOTPRINT*

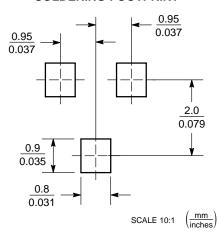


Figure 19. SOT-23

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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